N-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified
- · Surface-mounted package
- Halogen and Antimony Free(HAF), **RoHS** compliant



- Portable appliances
- · Battery management





1. Drain 2. Drain 3. Gate 4. Sourse 5. Drain 6. Drain DFN2020-6HMA Plastic Package

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Absolute Maximum Ratings (at Ta = 25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	30	V
Drain-Gate Voltage	V _{GS}	± 20	V
Drain Current	١D	10	A
Peak Drain Current, Pulsed ¹⁾	І _{DM}	40	А
Total Power Dissipation ²⁾	P _{tot}	700	mW
Operating Junction and Storage Temperature Range	Tj, Tstg	- 55 to + 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit	
Thermal Resistance-Junction to Ambient ²⁾	Steady State	RθJA	178	°C/W

¹⁾ Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature T_J(MAX) = 150°C. ²⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



Characteristics at $T_a = 25^{\circ}C$ unless otherwise specified

Parameter	Symbol	Min.	Тур.	Max.	Unit
STATIC PARAMETERS		•	•	•	
Drain-Source Breakdown Voltage at I _D = 250 μA	V _{(BR)DSS}	30	-	-	V
Drain-Source Leakage Current at V _{DS} = 24 V	IDSS	-	-	1	μA
Gate-Source Leakage Current at V _{GS} = ± 16 V	lgss	-	-	± 100	nA
Gate-Source Threshold Voltage at V _{GS} = V _{DS} , I _D = 250 μA	V _{GS(th)}	1	-	2.5	V
Drain-Source On-State Resistance at V_{GS} = 10 V, I_D = 10 A at V_{GS} = 4.5 V, I_D = 8 A	R _{DS(on)}	-	-	20 32	mΩ
DYNAMIC PARAMETERS			1	.	
Gate Resistance at V _{DS} = 0 V, V _{GS} = 0 V, f = 1 MHz	Rg	-	1.7	-	Ω
Forward Transconductance at V_{DS} = 5 V, I_D = 4 A	g fs	-	6	-	S
Input Capacitance at $V_{GS} = 0 V$, $V_{DS} = 15 V$, f = 1 MHz	Ciss	-	448	-	pF
Output Capacitance at V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz	Coss	-	63	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0 V$, $V_{DS} = 15 V$, f = 1 MHz	Crss	-	40	-	pF
Total Gate Charge at V_{DS} = 20 V, I_D = 4 A, V_{GS} = 10 V at V_{DS} = 20 V, I_D = 4 A, V_{GS} = 4.5 V	Qg	-	11.7 5.8	-	nC
Gate to Source Charge at V_{DS} = 20 V, I_D = 4 A, V_{GS} = 10 V	Qgs	-	1.7	-	nC
Gate to Drain Charge at V_{DS} = 20 V, I_D = 4 A, V_{GS} = 10 V	Q_{gd}	-	2.9	-	nC
Turn-On Delay Time at V _{DD} = 20 V, V _{GS} = 10 V, I _D = 4 A, R _g = 4.7 Ω	t _{d(on)}	-	10.2	-	nS
Turn-On Rise Time at V _{DD} = 20 V, V _{GS} = 10 V, I _D = 4 A, R _g = 4.7 Ω	tr	-	17	-	nS
Turn-Off Delay Time at V _{DD} = 20 V, V _{GS} = 10 V, I _D = 4 A, R _g = 4.7 Ω	$t_{\text{d(off)}}$	-	10	-	nS
Turn-Off Fall Time at V _{DD} = 20 V, V _{GS} = 10 V, I _D = 4 A, R _g = 4.7 Ω	t _f	-	9.6	-	nS
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at I _S = 1 A	V _{SD}	-	-	1	V
Body-Diode Continuous Current	ls	-	-	10	А
Body Diode Reverse Recovery Time at $I_s = 4 A$, di/dt = 100 A / μs	t _{rr}	-	6.6	-	nS
Body Diode Reverse Recovery Charge at $I_S = 4 \text{ A}$, di/dt = 100 A / μ s	Qrr	-	2	-	nC



Electrical Characteristics Curves





Electrical Characteristics Curves





MMV03N032LS-CH

Test Circuits





Package Outline Dimensions (Units: mm)

DFN2020-6HMA



UNIT	А	A1	A3	b	D	D2	D2a	Е	E2	E2a	L
mm	0.55	0	0.15	0.25	1.95	0.85	0.33	1.95	1.05	0.65	0.225
11111	0.65	0.05	Тур.	0.35	2.05	1.05	0.43	2.05	1.25	0.75	0.325

UNIT	е	e2	e3	e4	k	k1	k2	z	z1	z2
mm	0.65	0.863	0.7	0.325	0.37	0.15	0.36	0.2	0.11	0.2
	BSC	BSC	BSC	BSC	BSC	BSC	BSC	BSC	BSC	BSC

Recommended Soldering Footprint



Packing information

Tape Width			Pitch Reel Size			Der Deel Deeling Overstite	
Раскаде	(mm)	mm	inch	mm	inch	Per Reel Packing Quantity	
DFN2020-6HMA	8	4 ± 0.1	0.157 ± 0.004	178	7	4,000	

Marking information

" NH " = Part No.
" • " = HAF (Halogen and Antimony Free)
" YYWW " = Date Code Marking
" Y " = Year (ex: 19 = 2019)
" W " = Week (ex: 09 = the 9th week of the year)
Font type: Arial

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